

The motivation for LArPix is to enable large liquid Argon TPCs to record multiple particle interactions per pulse of the neutrino beam. In addition to this increased “hit rate” capability ( $\sim 1$  us), another benefit is the reduced trajectory ambiguity achievable with a pixel detector. The feasibility of the pixel sensor array approach has been demonstrated by the LHEP group at U. Bern. The LArPix ASIC seeks to evolve that initial proof of concept towards a working detector system by using a full-custom micropower ASIC solution. A LArPix-based TPC is the primary approach planned for the DUNE near detector.



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- The figure consists of two parts. On the left is a 'TPC module diagram Top View' showing a rectangular module with a central blue horizontal band labeled 'Cathode' and two pink horizontal bands at the top and bottom labeled 'Pixel plane'. A red arrow labeled 'Beam' points from the left towards the cathode. A scale bar above the module indicates a length of 1 m. On the right is a 'TPC module CAD' showing a 3D perspective of the module. It features a yellow cathode plane and pink pixel planes, with a blue beam pipe at the top. A label 'Pixel plane' with a line points to one of the pink planes.



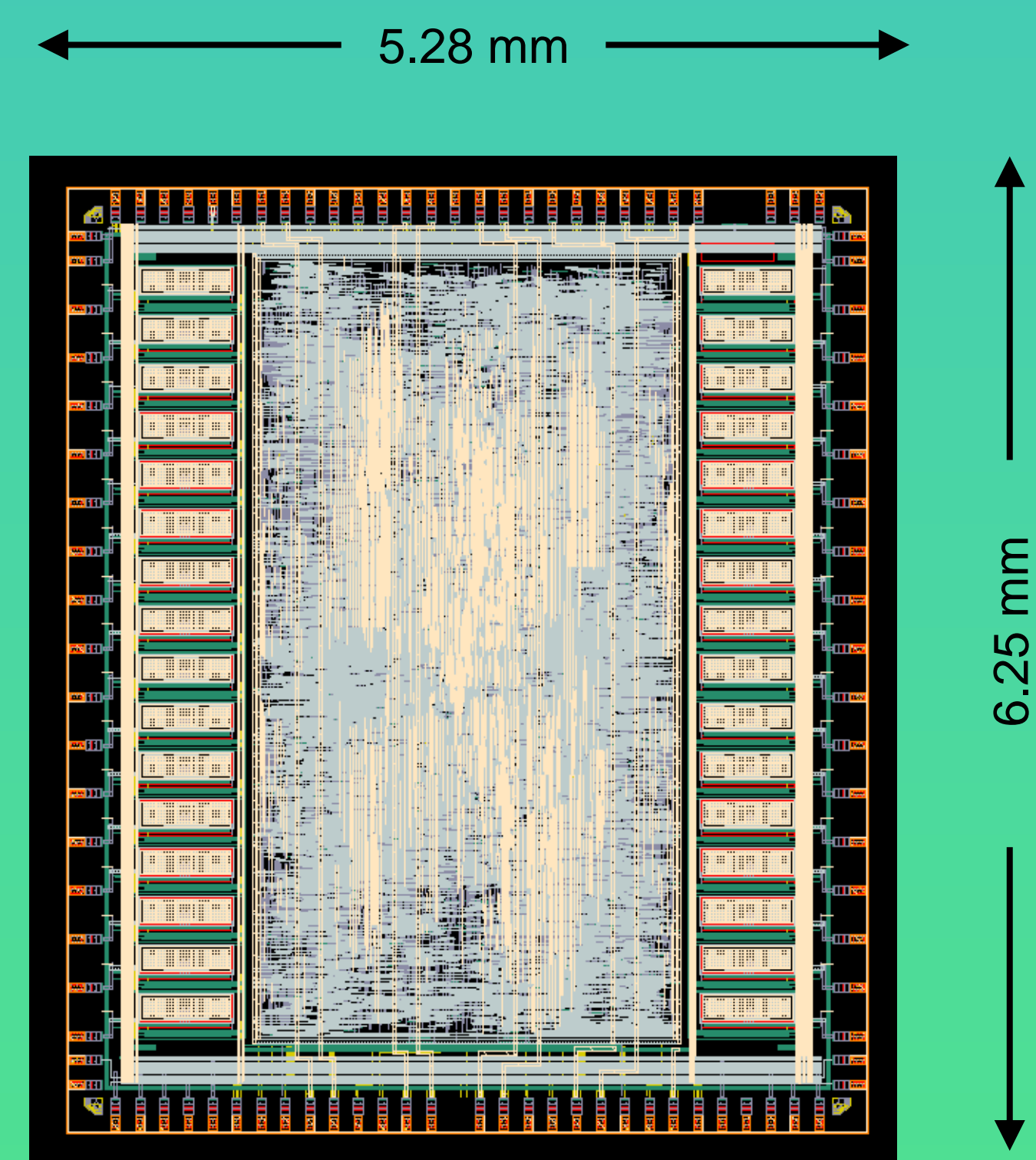
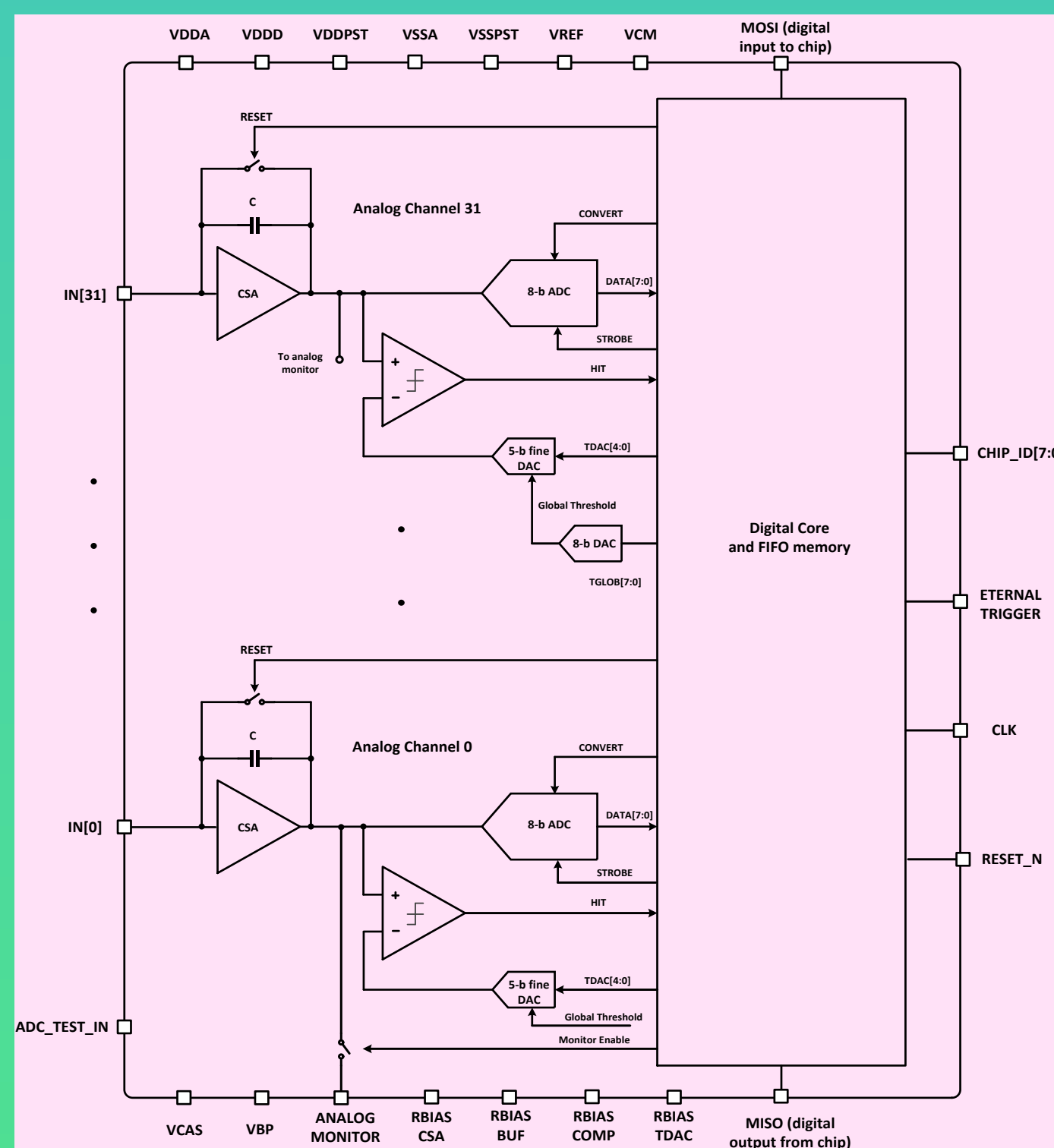
- ## Design Challenges

- Increased Vt-mismatch at 88 K
  - 5-bit per-channel threshold trim
- Low power – less than 100 uW/ch
  - Weak Inversion design
  - SAR ADC
- Hot electron damage
  - Non-minimum MOS length\*

\* Li, Shaorui, et al. "LAr TPC Electronics CMOS Lifetime at 300 K and 77 K and Reliability Under Thermal Cycling", IEEE Transactions on Nuclear Science, vol. 60, no. 6, 12/2013

## Additional Features

- Front-End Gain select
- Front-End Bypass
- Power Supply Bypass select
- Analog Monitor Bus
- Analog Test Pulse
- Cross-Trigger
- Periodic Reset
- Sampling Pulse Stretching
- ADC Burst
- Channel Mask
- External Trigger Mask



- AFE readout of a synthesized event stream
- ~15 ke- event followed by a ~250 ke- event
- Periodic reset, with event reset
- Temperature 300 K and 88 K



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- ArgonCUBE  
Courtesy of U. Bern



180 nm RF/Mixed Signal process — Submission June 2017 — Devices due back from fab Sept 2017

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